

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems



G S D-PAK (TO-252)

For current package drawing, please refer to the Fairchild website at http://www.fairchildsemi.com/package-drawings/TO/ TO252A03.pdf.

MOSFET Maximum Ratings T_J = 25°C unless otherwise noted.

| Symbol | Parameter | Ratings | Units | | |
|---|---|-----------------------|--------------|-------------------|--|
| V _{DSS} | Drain-to-Source Voltage | | 60 | V | |
| V _{GS} | Gate-to-Source Voltage | | ±20 | V | |
| | Drain Current - Continuous (V _{GS} =10) (Note 1) | T _C =25°C | 100 | • | |
| D | Pulsed Drain Current | T _C = 25°C | See Figure 4 | Α | |
| E _{AS} | Single Pulse Avalanche Energy | (Note 2) | 115 | mJ | |
| D | Power Dissipation | | 227 | W | |
| P _D Derate Above 25 ^o C | | | 1.52 | W/ ^o C | |
| T _J , T _{STG} | Operating and Storage Temperature | | -55 to + 175 | °C | |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | | 0.66 | °C/W | |
| R _{0JA} | Maximum Thermal Resistance, Junction to Ambient | (Note 3) | 52 | °C/W | |

Notes:

1: Current is limited by bondwire configuration.

2: Starting $T_J = 25^{\circ}C$, $L = 40\mu$ H, $I_{AS} = 76A$, $V_{DD} = 60V$ during inductor charging and $V_{DD} = 0V$ during time in avalanche.

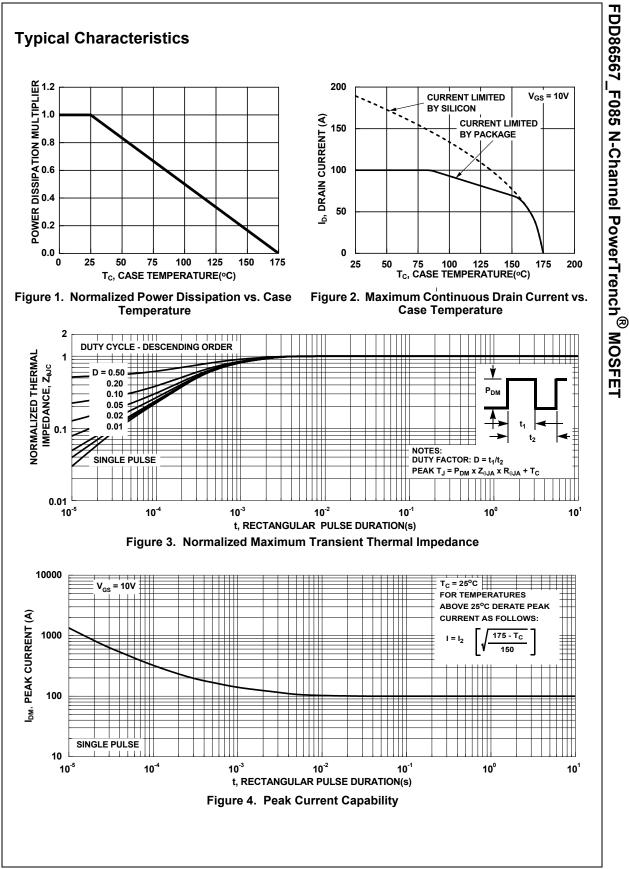
3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

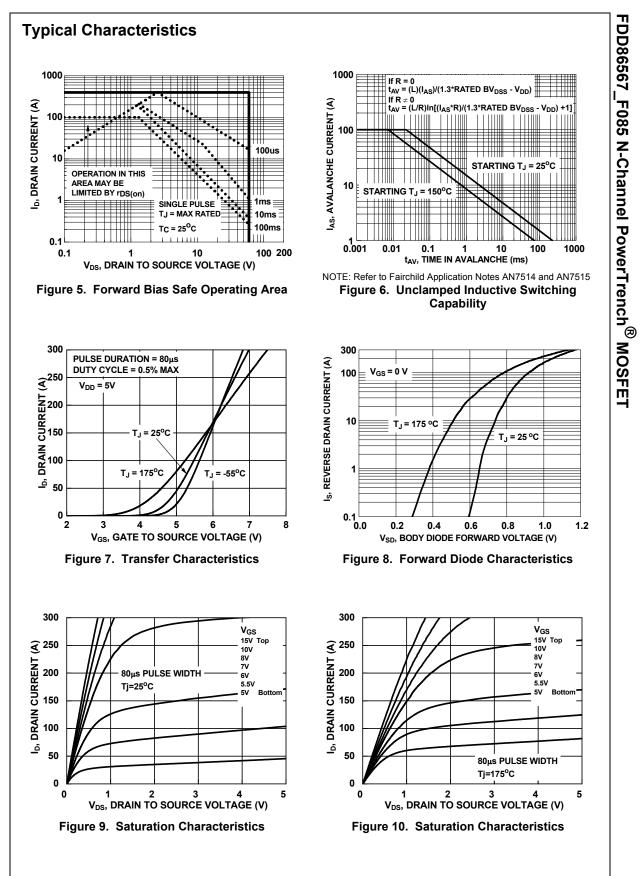
Package Marking and Ordering Information

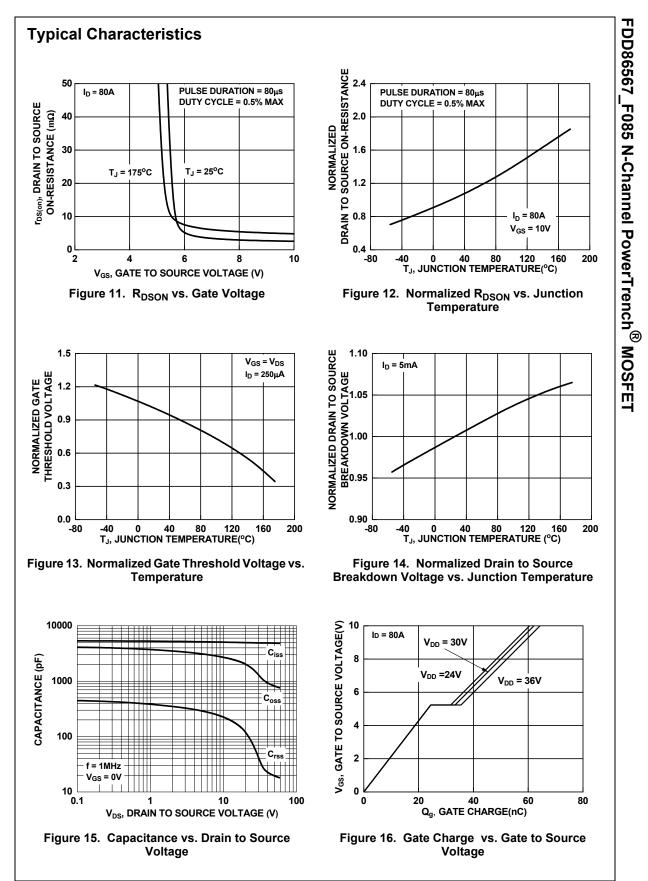
| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|---------------|---------------|-----------|------------|-----------|
| FDD86567 | FDD86567_F085 | D-PAK(TO-252) | 13" | 16mm | 2500units |

July 2015

| Symbol | Parameter | Test Conditions | | Min. | Тур. | Max. | Units | |
|--------------------------------------|--|---|--|---|------------|------|----------|----------|
| Off Cha | aracteristics | | | | L | | 1 | |
| B _{VDSS} | Drain-to-Source Breakdown Voltage | I _D = 250μA, | $V_{GS} = 0$ | V | 60 | - | - | V |
| 1000 | <u> </u> | $V_{DS}=60V$, $T_J=25^{\circ}C$ | | - | - | 1 | μA | |
| I _{DSS} | Drain-to-Source Leakage Current | | | 75°C (Note 4) | - | - | 1 | mA |
| I _{GSS} | Gate-to-Source Leakage Current | V _{GS} = ±20V | | - | - | ±100 | nA | |
| On Cha | racteristics | | | | | | | |
| V _{GS(th)} | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}$, | V _{GS} = V _{DS} , I _D = 250μA | | 2 | 2.9 | 4 | V |
| | Drein to Source On Desistance | | | | - | 2.6 | 3.2 | mΩ |
| R _{DS(on)} | Drain to Source On Resistance | V _{GS} = 10V | | 75°C (Note 4) | - | 4.9 | 6.0 | mΩ |
| C _{oss} C _{rss} | Output Capacitance Reverse Transfer Capacitance | f = 1MHz | | - | 1300 45 | - | pF pF | |
| C _{iss} | Input Capacitance | $V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz $V_{GS} = 0.5V, f = 1MHz$ | | - | 4950 | - | pF | |
| | | | | | | _ | | |
| R _g | Gate Resistance | | | - | 2.3 | - | Ω | |
| Q _{g(ToT)} | Total Gate Charge | V _{GS} = 0 to 1 | | V _{DD} = 48V | - | 63 | 82 | nC |
| $Q_{g(th)}$ | Threshold Gate Charge | V _{GS} = 0 to 2 | | v _{DD} = 40v I _D = 80A | - | 9.1 | - | nC |
| Q _{gs} | Gate-to-Source Gate Charge | 00 | | .D. con | - | 24 | - | nC |
| Q _{gd} | Gate-to-Drain "Miller" Charge | - | | - | 10 | - | nC | |
| | ing Characteristics | | | | Γ | | 405 | |
| t _{on} | Turn-On Time | | | | - | - | 105 | ns |
| t _{d(on)} ↓ | Turn-On Delay | | | ٨ | - | 24 | - | ns |
| t _r | Rise Time Turn-Off Delay | $V_{DD} = 30V,$ | I _D = 80 P | A, : 60 | - | 45 | - | ns |
| | | V_{GS} = 10V, R_{GEN} = 6 Ω | | - | 32 | - | ns | |
| t _{d(off)} | | | | | | 10 | | |
| | Fall Time Turn-Off Time | _ | | | - | 13 | - 59 | ns ns |







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